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July 3, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

FUJISAWA et al.

Filed:

July 3, 2003

For:

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

(AS AMENDED)

PRELIMINARY AMENDMENT

Mail Stop Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Please amend the above-identified application, prior to examination thereof, as follows:

IN THE SPECIFICATION

Please delete the original title in its entirety, and substitute therefor the following new title:

--METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE--.

Page 1, between the title and the heading "BACKGROUND OF THE INVENTION", please insert the following new paragraph:

--This application is a Continuation of Application No. 10/214,313, filed August 8, 2002, which is a Continuation of Application No. 09/594,046, filed June 15, 2000, which is a Divisional of Application No. 09/126,438, filed July 30, 1998, now U.S. Patent No. 6,232,650, issued May 15, 2001, the entire disclosure of No. 09/126,438 being incorporated herein by reference.--